⚡PERICOM®

## Fast CMOS Octal D Flip-Flop with Master Reset

Features

- Pin compatible with bipolar FAST™ Series at a higher speed and lower power consumption
- TTL input and output levels
- Low ground bounce outputs
- Extremely low static power
- Hysteresis on all inputs
- Industrial operating temperature range: –40°C to +85°C
- Packaging (Pb-free & Green available):
  – 20-pin 173-mil wide plastic TSSOP (L)
  – 20-pin 150-mil wide plastic QSOP (Q)
  – 20-pin 300-mil wide plastic SOIC (S)

Description

Pericom Semiconductor's PI74FCT273T is a 8-bit wide octal designed with eight edge-triggered D-type flip-flops with individual D inputs and O outputs. The common buffered Clock (CP) and Master Reset ($\overline{MR}$) load and resets (clear) all flip-flops simultaneously. The register is fully edge-triggered. The D input state, one setup time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's O output. All outputs will be forced LOW independently of Clock or Data inputs by a LOW voltage level on the $\overline{MR}$ input.

Device models available upon request.

Block Diagram
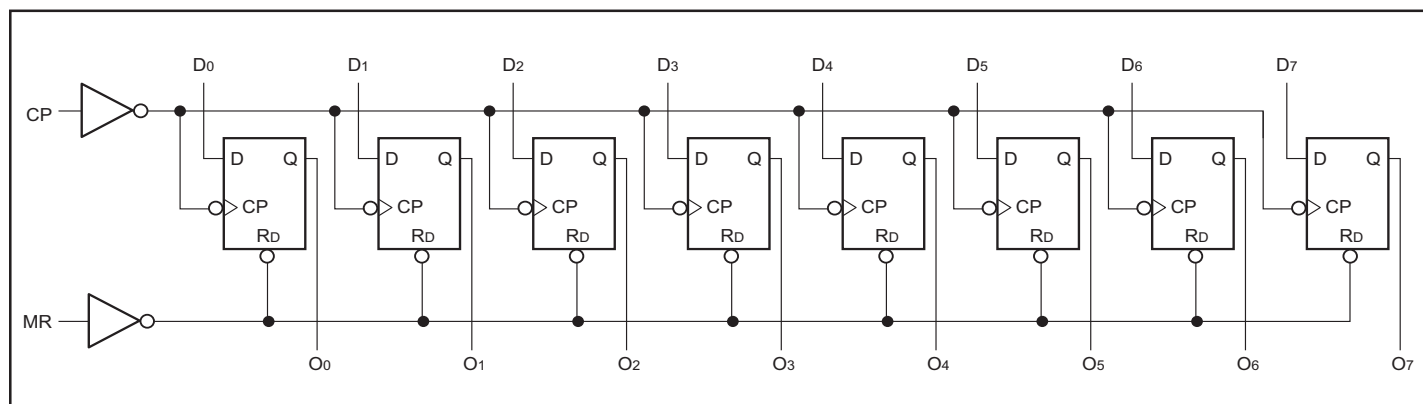
Pin Configuration
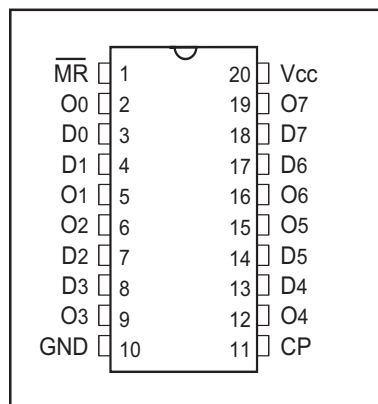
Pin Description

Pin Name	Description
$\overline{MR}$	Master Reset (Active LOW)
CP	Clock Pulse Input (Active Rising Edge)
D0-D7	Data Inputs
O0-O7	Data Outputs
GND	Ground
V_{CC}	Power

Truth Table[1]

	Inputs			Outputs
Mode	$\overline{MR}$	CP	D_N	O_N
Reset (Clear)	L	X	X	L
Load "1"	H	↑	h	H
Load "0"	H	↑	l	L

1. H = High Voltage Level
   h = High Voltage Level one setup time prior to the LOW-to-HIGH Clock transition
   L = Low Voltage Level
   l = LOW Voltage Level one setup time prior to the LOW-to-HIGH Clock Transition
   X = Don't Care
   ↑ = LOW-to-HIGH Clock Transition

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	–65°C to +150°C
Ambient Temperature with Power Applied	-40°C to +85°C
Supply Voltage to Ground Potential (Inputs & Vcc Only)	–0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only) ..	–0.5V to +7.0V
DC Input Voltage	–0.5V to +7.0V
DC Output Current	120 mA
Power Dissipation	0.5W

Note:
Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, $T_A = -40°C$ to $+85°C$, $V_{CC} = 5.0V \pm 5\%$)

Parameters	Description	Test Conditions[1]		Min.	Typ[2]	Max.	Units
V_{OH}	Output HIGH Voltage	$V_{CC} = Min., V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -15.0mA$	2.4	3.0		V
V_{OL}	Output LOW Current	$V_{CC} = Min., V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 64mA$		0.3	0.55	V
V_{OL}	Output LOW Current	$V_{CC} = Min., V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 12mA$		0.3	0.50	V
V_{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level		2.0			V
V_{IL}	Input LOW Voltage	Guaranteed Logic LOW Level				0.8	V
I_{IH}	Input HIGH Current	$V_{CC} = Max.$	$V_{IN} = V_{CC}$			1	µA
I_{IL}	Input LOW Current	$V_{CC} = Max.$	$V_{IN} = GND$			–1	µA
I_{OZH}	High Impedance	$V_{CC} = Max.$	$V_{OUT} = 2.7V$			1	µA
I_{OZL}	Output Current		$V_{OUT} = 0.5V$			–1	µA
V_{IK}	Clamp Diode Voltage	$V_{CC} = Min., I_{IN} = -18mA$			–0.7	–1.2	V
I_{OFF}	Power Down Disable	$V_{CC} = GND, V_{OUT} = 4.5V$				100	µA
I_{OS}	Short Circuit Current	$V_{CC} = Max.^{(3)}, V_{OUT} = GND$		–60	–120		mA
V_H	Input Hysteresis				200		mV

Notes:
1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at Vcc = 5.0V, +25°C ambient and maximum loading.
3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.

Capacitance ($T_A = 25°C$, $f = 1$ MHz)

Parameters[1]	Description	Test Conditions	Typ	Max.	Units
C_{IN}	Input Capacitance	$V_{IN} = 0V$	6	10	pF
C_{OUT}	Output Capacitance	$V_{OUT} = 0V$	8	12	pF

Notes:
1. This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters	Description	Test Conditions[1]		Min.	Typ[2]	Max.	Units
I_{CC}	Quiescent Power Supply Current	V_{CC} = Max.	V_{IN} = GND or V_{CC}		0.1	500	µA
ΔI_{CC}	Supply Current per per Input @ TTL HIGH	V_{CC} = Max.	V_{IN} = 3.4V[3]		0.5	2.0	mA
I_{CCD}	Supply Current per Input per MHx[4]	V_{CC} = Max., Outputs Open $\overline{MR}$ = Vcc, One Input Toggling 50% Duty Cycle	V_{IN} = V_{CC} V_{IN} = GND		0.15	0.25	mA/ MHz
I_C	Total Power Supply Current[6]	V_{CC} = Max., Outputs Open f_{CP} = 10 MHz, 50% Duty Cycle $\overline{MR}$ = Vcc, 50% Duty Cycle One Bit toggling at fi = 5 MHz	V_{IN} = V_{CC} V_{IN} = GND V_{IN} = 3.4V V_{IN} = GND		1.5 2.0	3.5[5] 3.5[5]	mA
		V_{CC} = Max., Outputs Open f_{CP} = 10 MHz, 50% Duty Cycle $\overline{MR}$ = V_{CC}, 50% Duty Cycle Eight Bits toggling at fi = 2.5 MHz, 50% Duty Cycle	V_{IN} = V_{CC} V_{IN} = GND V_{IN} = 3.4V V_{IN} = GND		3.8 6.0	7.3[5] 16.3[5]	

Notes:
1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
2. Typical values are at Vcc = 5.0V, +25°C ambient.
3. Per TTL driven input (V_{IN} = 3.4V); all other inputs at Vcc or GND.
4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
5. Values for these conditions are examples of the Icc formula. These limits are guaranteed but not tested.
6. $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$
   $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP}/2 + f_i N_I)$
   I_{CC} = Quiescent Current
   ΔI_{CC} = Power Supply Current for a TTL High Input (V_{IN} = 3.4V)
   D_H = Duty Cycle for TTL Inputs High
   N_T = Number of TTL Inputs at D_H
   I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)
   f_{CP} = Clock Frequency for Register Devices (Zero for Non-Register Devices)
   f_i = Input Frequency
   N_I = Number of Inputs at f_i
   All currents are in milliamps and all frequencies are in megahertz.

Switching Characteristics over Operating Range

Parameters	Description	Conditions	273T Com. Min	273T Com. Max	273AT Com. Min	273AT Com. Max	273CT Com. Min	273CT Com. Max	Unit
t$_{PLH}$ t$_{PHL}$	Propagation Delay[1] CP to O$_N$	C$_L$ = 50pF R$_L$ = 500Ω	2.0	13.0	2.0	7.2	2.0	5.8	ns
t$_{PHL}$ t$_{PLH}$	Propagation Delay[1] $\overline{MR}$ to O$_N$		2.0	13.0	2.0	7.2	2.0	6.1	ns
t$_{SU}$	Setup Time, HIGH or LOW Dn to CP		3.0		2.0		2.0		ns
t$_H$	Hold Time, HIGH or LOW Dn to CP		2.0		1.5		1.5		ns
t$_W$	CP Pulse Width[2] HIGH or LOW		7.0		6.0		6.0		ns
t$_W$	$\overline{MR}$ Pulse Width[2] LOW		7.0		6.0		6.0		ns
t$_{REM}$	Recovery Time MR to CP[2]		4.0		2.0		2.0		ns

Notes:
1. Minimum limits are guaranteed but not tested on Propagation Delays.
2. This parameter guaranteed but not production tested.

Packaging Mechanical: 20-pin SOIC (S)

DOCUMENT CONTROL NO.
PD - 1006

REVISION: D
DATE: 03/09/05

.2914 / .2992 → 7.40 / 7.60

.496 / .511 → 12.60 / 12.99

20

1

.020 / .030 → 0.508 / 0.762 REF

.0926 / .1043 → 2.35 / 2.65

SEATING PLANE

.0040 / .0118 → 0.10 / 0.30

.050 BSC → 1.27

.013 / .020 → 0.33 / 0.51

.010 / .029 → 0.254 / 0.737 x 45°

0-8°

.0091 / .0125 → 0.23 / 0.32

0.41 / 1.27 .016 / .050

.394 / .419

10.00 / 10.65

X.XX / X.XX DENOTES CONTROLLING DIMENSIONS IN MILLIMETERS

Notes:
1) Controlling dimensions in millimeters.
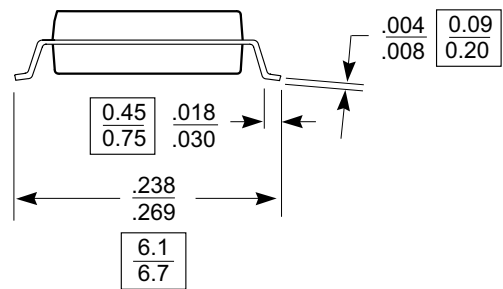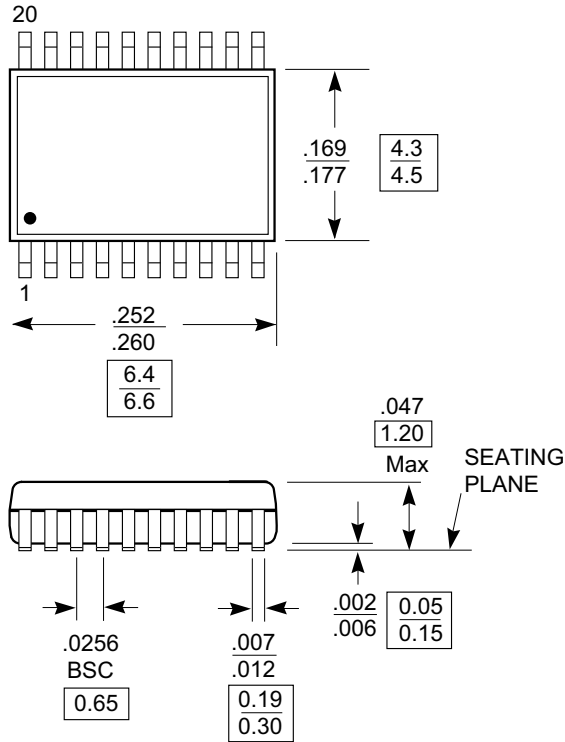2) Ref: JEDEC MS-013D/AC

Pericom Semiconductor Corporation
3545 N. 1st Street, San Jose, CA 95134
1-800-435-2335 • www.pericom.com

DESCRIPTION: 20-Pin, 300-Mil Wide, SOIC

PACKAGE CODE: S

Packaging Mechanical: 20-Pin TSSOP (L)

DOCUMENT CONTROL NO.
PD - 1311

REVISION: E
DATE: 03/09/05

20

1

$\dfrac{.169}{.177}$ $\dfrac{4.3}{4.5}$

$\dfrac{.252}{.260}$

$\dfrac{6.4}{6.6}$

$\dfrac{.047}{1.20}$ Max

SEATING PLANE

.0256 BSC
0.65

$\dfrac{.007}{.012}$
$\dfrac{0.19}{0.30}$

$\dfrac{.002}{.006}$ $\dfrac{0.05}{0.15}$

$\dfrac{.004}{.008}$ $\dfrac{0.09}{0.20}$

$\dfrac{0.45}{0.75}$ $\dfrac{.018}{.030}$

$\dfrac{.238}{.269}$

$\dfrac{6.1}{6.7}$

Note:
1. Package Outline Exclusive of Mold Flash and Metal Burr
2. Controlling dimentions in millimeters
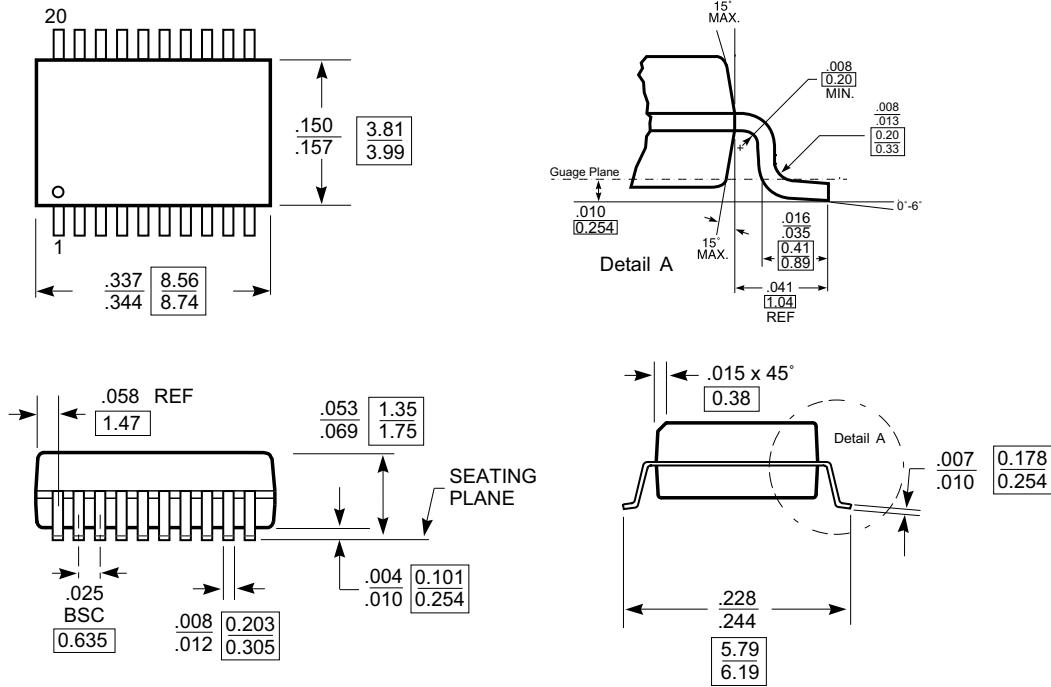3. Ref: JEDEC MO-153F/AC

Pericom Semiconductor Corporation
3545 N. 1st Street, San Jose, CA 95134
1-800-435-2335 • www.pericom.com

DESCRIPTION: 20-Pin, 173-Mil Wide, TSSOP

PACKAGE CODE: L

Packaging Mechanical: 20-pin QSOP (Q)

	DOCUMENT CONTROL NO. PD - 1202
	REVISION: H DATE: 10/22/07

20

.150 / .157 [3.81 / 3.99]

1

.337 / .344 [8.56 / 8.74]

15° MAX.

.008 [0.20] MIN.

.008 / .013 [0.20 / 0.33]

Guage Plane

.010 [0.254]

15° MAX.

.016 / .035 [0.41 / 0.89]

0°-6°

.041 [1.04] REF

Detail A

.058 REF [1.47]

.053 / .069 [1.35 / 1.75]

SEATING PLANE

.025 BSC [0.635]

.008 / .012 [0.203 / 0.305]

.004 / .010 [0.101 / 0.254]

.015 x 45° [0.38]

Detail A

.007 / .010 [0.178 / 0.254]

.228 / .244 [5.79 / 6.19]

| X.XX / X.XX | DENOTES DIMENSIONS
IN MILLIMETERS |

Note:
1) Controlling dimensions in inches.
2) Ref: JEDEC MO-137B/AD
3) Dimensions do not include mold flash, protrusions or gate burrs

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DESCRIPTION: 20-Pin, 150-Mil Wide, QSOP

PACKAGE CODE: Q

Ordering Information

Ordering Code	Package Code	Speed Grade	Package Type
PI74FCT273TQ	Q	Blank	20-pin QSOP
PI74FCT273TSE	S	Blank	Pb-free & Green, 20-pin SOIC
PI74FCT273ATL	L	A	20-pin TSSOP
PI74FCT273ATS	S	A	20-pin SOIC
PI74FCT273ATSE	S	A	Pb-free & Green, 20-pin SOIC
PI74FCT273ATQ	Q	A	20-pin QSOP

Notes:
• Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
• E = Pb-free & Green
• Adding an X suffix = Tape/Reel

Part Marking Information

Pericom's standard product mark follows our standard part number ordering information, except for those products with a speed letter code. For marking purposes, the speed letter code mark is placed after the package code letter, rather than after the device number as it is ordered.

Although all products are marked immediately after assembly to assure material traceability, Pericom does not usually mark the speed code at that time. After electrical test screening and speed binning have been completed, we then perform an "add mark" operation which places the speed code letter at the end of the complete part number.

Please refer to the example shown below:
• Part Number as ordered: PI74FCT245ATQ
• Example of Part Number as marked:

```
PI74FCT
245TQ A
0010BSC
```

"A" is the speed code letter identifier
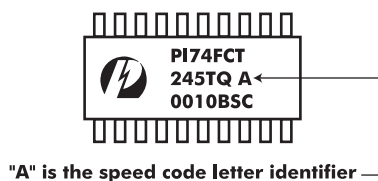
Notes:
1) 8-pin DIP, 8-pin SOIC, 8-pin TSSOP, 14-pin SOIC, 16-pin QSOP, SC70, MSOP, and SOT23 packages are not marked with the Pericom logo due to space limitations on the package.